

#### Doc.Version:03

Customer Approval:	
□ Accept	🗌 Reject

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□ APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

WIMRD005-02-C



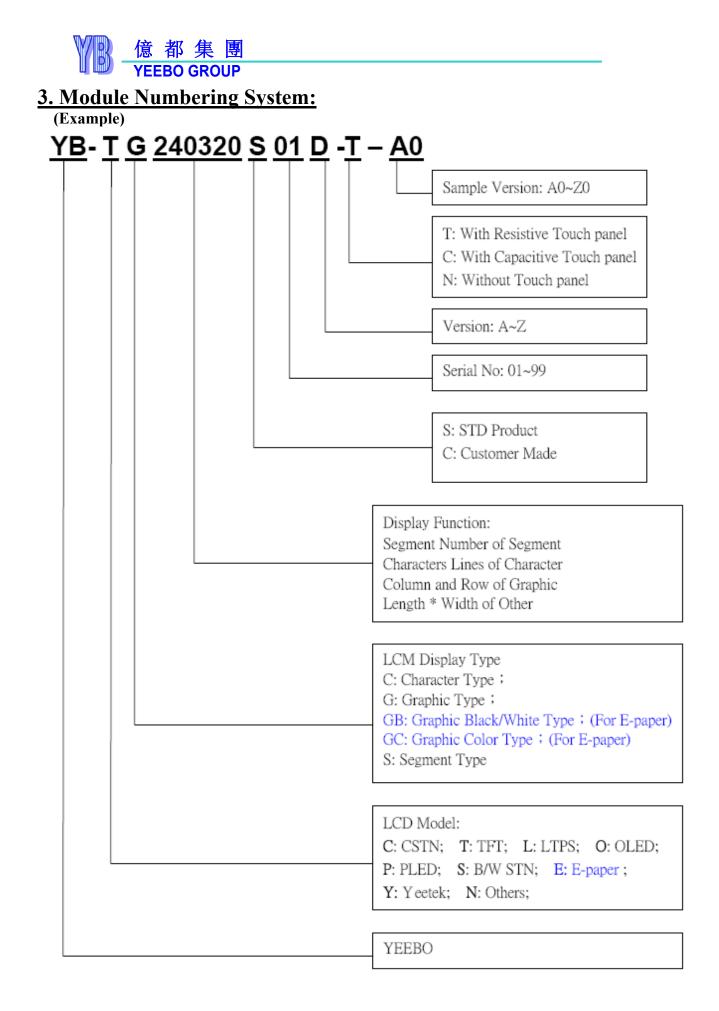
## **<u>1. Revision History</u>**

Sample Version	DOC. Version	DATE		DESCRIPTION			
A0	00	2014-12-22	SPEC ONLY	First issue	Fanny / Jimmy		
A0	01	2015-02-17	FULL SPEC	First Sample	Fanny / Jimmy		
A0	02	2015-11-03	FULL SPEC	Add NTSCP.11	Fanny / Jimmy		
A1	03	2017-05-09	FULL SPEC	Change CTP ICP.9	Fanny / Fen		



## **<u>2. Table of Contents:</u>**

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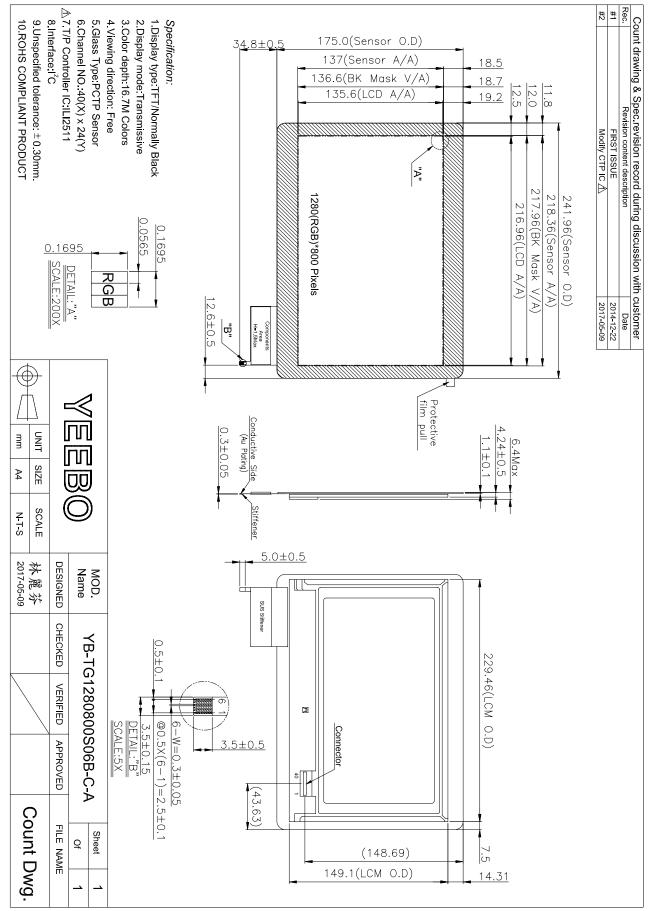


## 4. General Specification:

ITEM	CONTENTS
Module Size	241.96(W) * 175.0(H) * 6.4(T) mm
Module Size(With FPC)	241.96(W) *209.8 (H) * 6.4 (T) mm
Display Size(Diagonal)	10.1 inch
Display Format	1280(RGB) * 800 Pixels
Active Area	216.96(W) * 135.6(H) mm
Pixel Pitch	0.1695 * 0.1695 mm
LCD Type	TFT(16.7M) / Transmissive / Normal Black / Glare
Touch panel Type	OLGS
View Direction	Free
CTP IC	ILI2511
Weight	272g



#### 5. LCM drawing:





## **<u>6. Electrical Characteristics</u>**

#### 6-1 Absolute Maximum Ratings

#### (Ta=25°C VSS=0V)

						/
Item	Symbol	Min.	Туре	Max.	Unit	Remark
Power Supply voltage	VDD	-0.3	-	7.0	Volt	
	VLED	-0.3	-	24.0	Volt	
Operating Temperature	Topr	-20	-	+70	°C	
Operating Humidity	Hopr	10		+90	%RH	
Storage Temperature	Tstg	-30	-	+80	°C	(1)(2)(3)
Storage Humidity	Hstg	10		+90	%RH	

Note :

- (1) Maximum Wet-Bulb temperature should be 39 degree C and no condensation.
- (2) When you apply the LCD module for OA system. Please make sure to keep the temperature of LCD module is less than 70°C
- (3) Storage / Operating temperature

#### **Touch panel controller ILI2511**

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Power Supply	VDD	3.0	3.3	3.6	Volt	-

#### **6-2 Operating Conditions**

6-2 Operating Condit	(Ta=25°C)					
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Power Supply voltage	VDD	3.0	3.3	3.6	Volt	
Power Supply Current	IDD	-	270	-	mA	
LCD Ripple Voltage	VDDrp	-	-	300	mV	



#### 6-3 LVDS Receiver

6-3-1 Signal Electrical Characteristics For LVDS Receiver

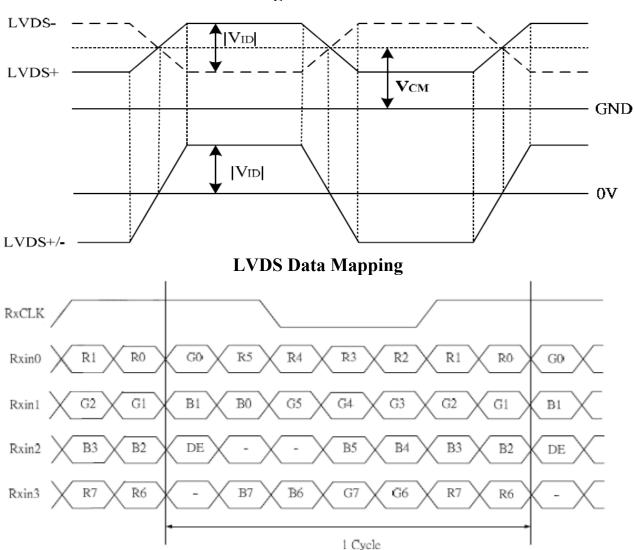
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Differential Input High	Vth	-	-	+100	mV	VCM=1.2V
Differential Input Low	Vtl	-100	-	-	mV	VCM=1.2V
Magnitude Differential Input	Vid	200	-	400	mV	-
Common Mode Voltage	Vсм	0.3+(VID/2)	-	VDD-1.2-(VID/2)	V	-
Common Mode Voltage	∆Vсм	-	-	50	mA	VCM=1.2V

Note

(1) Input signals shall be low or Hi-Z state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at

the interface connector of LCD.



#### **Voltage Definitions**



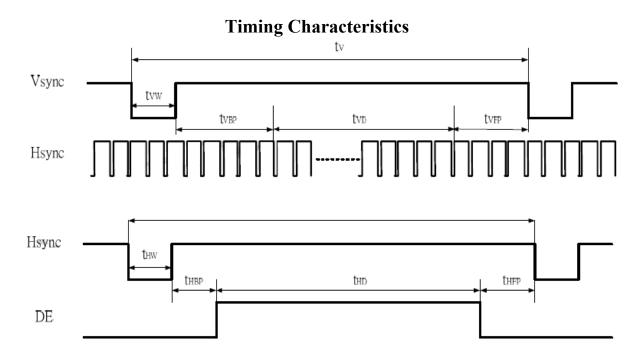
#### 6-4 Interface Timing

6-4-1 Timing Characteristics

Interface Timings									
Parameter	Symbol	Unit	Min.	Тур.	Max.				
Frame Rate		Hz	-	- 60					
Frame Period	tV	line	(815)	(815) (823)					
Vertical Display Time	tVD	line	800						
Vertical Blanking Time	tVW+tVBP+tVFP	line	(15)	(23)	(33)				
1 Line Scanning Time	tH	clock	(1410)	(1440)	(1470)				
Horizontal Display Time	tHD	clock	1280						
Horizontal Blanking Time	tHW+tHBP+tHFP	clock	(60)	(160)	(190)				
Clock Rate	1/TC	MHz	(68.9)	(71.1)	(73.4)				

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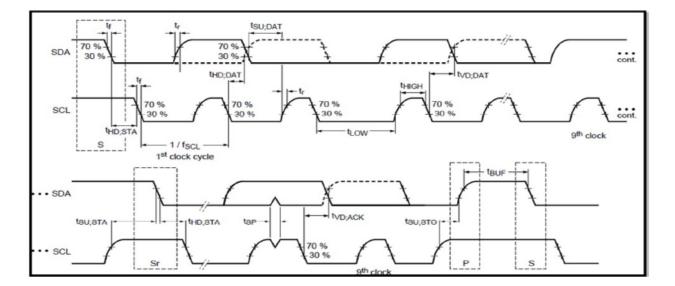
6-4-2 Timing Diagram of Interface Signal(DE mode)





6-4-3 Touch panel controller ILI2511

#### I2C AC Characteristics



#### I2C Interface

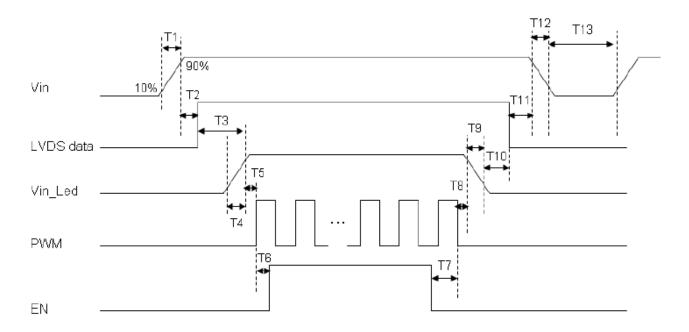
	_					
Description	Ormhal	Standard-	andard-mode		Fast-mode	
Parameter	Symbol	Min	Max	Min	Max	Unit
SCL clock frequency	f <sub>SCL</sub>	0	100	0	400	kHz
Hold time START condition	t <sub>hd;sta</sub>	4.0	-	0.6	-	us
LOW period of the SCL clock	t <sub>Low</sub>	4.7	-	1.3	-	us
HIGH period of the SCL clock	t <sub>High</sub>	4.0	-	0.6	-	us
Set-up time for a repeated START condition	t <sub>su:sta</sub>	4.7	-	0.6	-	us
Data hold time	t <sub>HD;DAT</sub>	300	-	300	-	ns
Data set-up time	t <sub>su;dat</sub>	250	-	100	-	ns
Rise time of both SDA and SCL signals (30% to 70%)	t <sub>r</sub>	-	1000	20	300	ns
Fall time of both SDA and SCL signals (70% to 30%)	t <sub>f</sub>	-	300	20	300	ns
Set-up time for STOP condition	t <sub>su;sто</sub>	4.0	-	0.6	-	us
Bus free time between a STOP and START condition	t <sub>BUF</sub>	4.7	-	1.3	-	us
Capacitive load for each bus line	Cb	-	400	-	400	pF
Noise margin at the LOW level for each connected device	V <sub>nL</sub>	0.1V <sub>DD</sub>	-	0.1V <sub>DD</sub>	-	v
Noise margin at the HIGH level for each connected device	V <sub>nH</sub>	0.2V <sub>DD</sub>	-	0.2V <sub>DD</sub>	-	v



#### 6-5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.

#### **Power Sequence**



#### **Power Sequencing Requirements**

Parameter	Symbol	Unit	Min	Тур.	Max
VIN Rise Time	T1	ms	0.5		10
VIN Good to Signal Valid	T2	ms	30		90
Signal Valid to Backlight On	Т3	ms	200		
Backlight Power On Time	T4	ms	0.5		
Backlight VDD Good to System PWM On	T5	ms	10		
System PWM ON to Backlight Enable ON	Т6	ms	10		
Backlight Enable Off to System PWM Off	T7	ms	0		
System PWM Off to B/L Power Disable	Т8	ms	10		
Backlight Power Off Time	Т9	ms	0.5	10	30
Backlight Off to Signal Disable	T10	ms	200		
Signal Disable to Power Down	T11	ms	0		50
VIN Fall Time	T12	ms	0.5	10	30
Power Off	T13	ms	500		



### 7. Optical Characteristics:

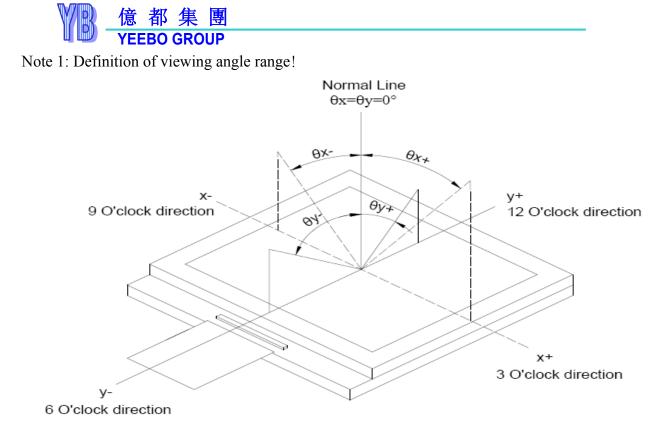
Itom	Item		mbol Conditions		cificat	ions	Unit Remark	Bomork
Item		Symbol	Conditions	Min	Тур	Max	Unit	Remark
Contrast I	Ratio	CR	Normal	600	800	-		Note 3
Response time		Rising +Falling	$\theta > \Phi > 1 \pm$		25	50	ms	Note 2
NTSC		-	-	-	45	-	%	Note 1
	Hor. –	θ∟	$\Phi=180^{\circ}(9 \text{ o'clock})$	75	85	-		
Viewing angle		θr	$\Phi=0^{\circ}(3 \text{ o'clock})$	75	85	-	dog	Note 1
$(CR \ge 10)$ B/L ON		θτ	Φ=90°(12 o'clock)	75	85	-	deg.	NOLE I
		θв	Φ=270°(6 o'clock)	75	85	-		

Measuring Condition

- 1. Measuring surrounding: dark room
- 2. Ambient temperature:  $25\pm2^{\circ}C$
- 3. 30 min. Warm-up time.

Color of CIE Coordinate:

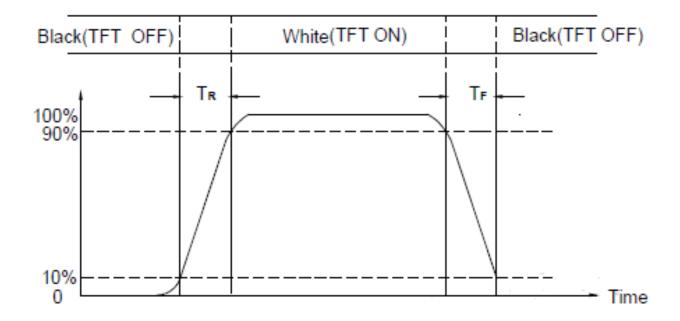
ltem		Symbol	Min.	Тур.	Max.
	D 1	х	0.511	0.561	0.611
	Red	у	0.284	0.334	0.384
	Green	Х	0.291	0.341	0.391
Chromaticity		у	0.518	0.568	0.618
Coordinates (Transmissive)	Blue	Х	0.111	0.161	0.211
(Transmissive)		у	0.079	0.129	0.179
	<b>X</b> 71 · 4	X	0.263	0.313	0.363
	White	у	0.279	0.329	0.379



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Note (2) Definition of Contrast Ratio(CR) :
measured at the center point of panel
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Contrast ratio (CR)=	Photo detector output when LCD is at "White" state
	Photo detector output when LCD is at "Black

Note (3) Definition of Response Time : Sum of TR and TF





# **8. Interface Pin Assignment:** 8-1 LCM FPC Interface

No.	Symbol	I/O	Function	Remark
1	NC		No Connection.	
2	VDD	Р	Power Voltage.	
3	VDD	Р	Power Voltage.	
4	NC		Internal testing pin. (No Connection)	
5	NC		Internal testing pin. (No Connection)	
6	NC		Internal testing pin. (No Connection)	
7	NC		No Connection	
8	RXIN0-	Ι	-LVDS differential data input	
9	RXIN0+	Ι	+LVDS differential data input	
10	GND	Р	Ground	
11	RXIN1-	Ι	-LVDS differential data input	
12	RXIN1+	Ι	+LVDS differential data input	
13	GND	Р	Ground	
14	RXIN2-	Ι	-LVDS differential data input	
15	RXIN2+	Ι	+LVDS differential data input	
16	GND	Р	Ground	
17	RXCLKIN-	Ι	-LVDS differential clock input	
18	RXCLKIN+	Ι	+LVDS differential clock input	
19	GND	Р	Ground	
20	RXIN3-	Ι	-LVDS differential data input	
21	RXIN3+	Ι	+LVDS differential data input	
22	GND	Р	Ground	
23	LED-	Р	Ground for LED Driving	
24	LED-	Р	Ground for LED Driving	
25	LED-	Р	Ground for LED Driving	
26	NC		No Connection	
27	LED_PWM	Р	PWM Input Signal for LED Driver	
28	LED_EN	Р	LED Enable Pin	
29	NC		Reserved For CABC (No Connection)	
30	NC		No Connection	



No.	Symbol	I/O	Function	Remark
31	LED+	Р	Power Supply for LED Driver	
32	LED+	Р	Power Supply for LED Driver	
33	LED+	Р	Power Supply for LED Driver	
34	NC		No Connection	
35	NC		Internal testing pin. (No Connection)	
36	NC		No Connection	
37	NC		No Connection	
38	NC		No Connection	
39	NC		No Connection	
40	NC		No Connection	

I: input, O: output, P: Power Note: All input signals shall be low or Hi- resistance state when VDD is off.

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#### 8-2 CTP Interface Pin

No.	Symbol	I/O	Function	Remark		
1	VDD	Р	Power Voltage for digital circuit			
2	RST	Ι	Reset			
3	INT	Ι	Interrupt			
4	SCL	Ι	I2C Serial Clock			
5	SDA	Ι	I2C Serial Data			
6	GND	Р	Power Voltage for digital circuit			
37.4			·	•		

Note: I2C Interface!

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#### 9. Backlight Characteristics:

9-1 LED driver Input and Output Specification (Ta=25°C)								
Item	Sym	ibol	Min.	Тур.	Max.	Unit	Note	
LED input Voltage	V_1	V_led		(12)	(21)	V	1	
LED Power Consumption	P_1	.ED	-	-	(2.5)	W	1	
LED Forward Voltage	V	F	(2.9)	-	(3.2)	V		
LED Forward Current	I	7	-	(20)	-	mA		
PWM Signal Voltage	VPWM_EN	High Low	(3.0) (0)	-	(3.6) (0.4)	V	1	
LED Enale Voltage	VLED_EN	High Low	(3.0)	-	(3.6) (0.4)	V		
		LOW	(0)	-	(0.4)			
			(1)	-	(2)		DDIM≥1% (1)	
Input PWM Frequency	FPWM		(2)	-	(5)	KHz	DDIM≥2.5% (1)	
r			(5)	-	(10)		DDIM≥5% (1)	
			(10)	-	(20)		DDIM≥10% (1)	
Luminous Intensity for LCM	Iv		250	300	-	cd/m <sup>2</sup>	2	
Uniformity for LCM	-		70	-	-	%	3	
Life Time	-		-	50000	-	Hr.	4	

NOTE:

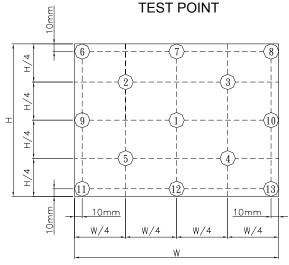
1. Operating temperature  $25^{\circ}$ C , humidity 50%.

2. Average Luminous Intensity of P1-P13

3. Uniformity = Min/Max \* 100%

4.LED life time defined as follows: The final brightness is at 50% of original brightness

## Measured Method: (X\*Y: Light Area)





## **10. Standard Specification for Reliability:** 10–1. Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at $-20^{\circ}$ C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at $80^{\circ}$ C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at $-30^{\circ}$ C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at $60^{\circ}$ C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles : -20°C for 30 minutes $\rightarrow$ normal temperature for 5 minutes $\rightarrow$ +60°C for 30 minutes $\rightarrow$ normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : $10Hz \sim 55Hz$ Amplitude of vibration : $1.5mm$ Sweep time: $12 min$ X,Y,Z 2 hours for each direction.
08	Packing drop test	According to ISTA 1A 2001.
09 Electrical Static	Air: ±6KV 150pF/330Ω 5 times	
	Discharge	Contact: $\pm 4$ KV 150pF/330 $\Omega$ 5 time

\*Sample size for each test item is 3~5pcs



10 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 10.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item Test Model		In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

#### 10-3. MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ( $25\pm5^{\circ}$ C), normal humidity ( $50\pm10\%$ RH), and in area not exposed to direct sun light.
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#### **<u>11. Specification of Quality Assurance:</u>**

#### 11-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by YEEBO CORPORATION (Supplier).

11-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

- c. Test of Appearance Characteristics:
  - According to the individual specification to test the product.
- d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

- e. Delivery Test:
  - Before delivering, the supplier should take the delivery test.

(i) Test method: According to ISO2859-1. General Inspection Level II take a single time.

(ii) The defects classify of AQL as following:

Major defect: AQL = 0.65%Minor defect: AQL = 2.5%

- Total defects: AQL = 2.5%
- 11-3. Non- conforming Analysis & Deal With Manners
  - a. Non- conforming Analysis:
    - (i) Purchaser should supply the detail data of non- conforming sample and the non-conforming.
    - (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
  - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
  - b. Disposition of non- conforming:
    - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
    - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non- conforming when the reason of nonconforming is not sure.

#### 11-4. Agreement items

Both sides should discuss together when the following problems happen.

- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.



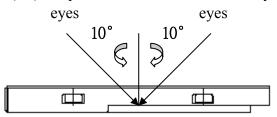
- 11-5. Standard of The Product Appearance Test
  - a. Manner of appearance test:

(i) The test must be under 20W  $\times$  2 or 40W fluorescent light, and the distance of view must be at 30±5cm.

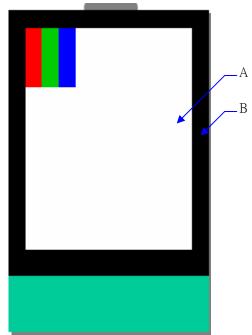
(ii) When test the model of transmissive product must add the reflective plate.

(iii)The test direction is base on around 10° of vertical line.

(iiii)Temperature:  $25\pm5^{\circ}$ C Humidity:  $60\pm10\%$ RH



(iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area.
  - (Outside viewing area)

b. Basic principle:

- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)



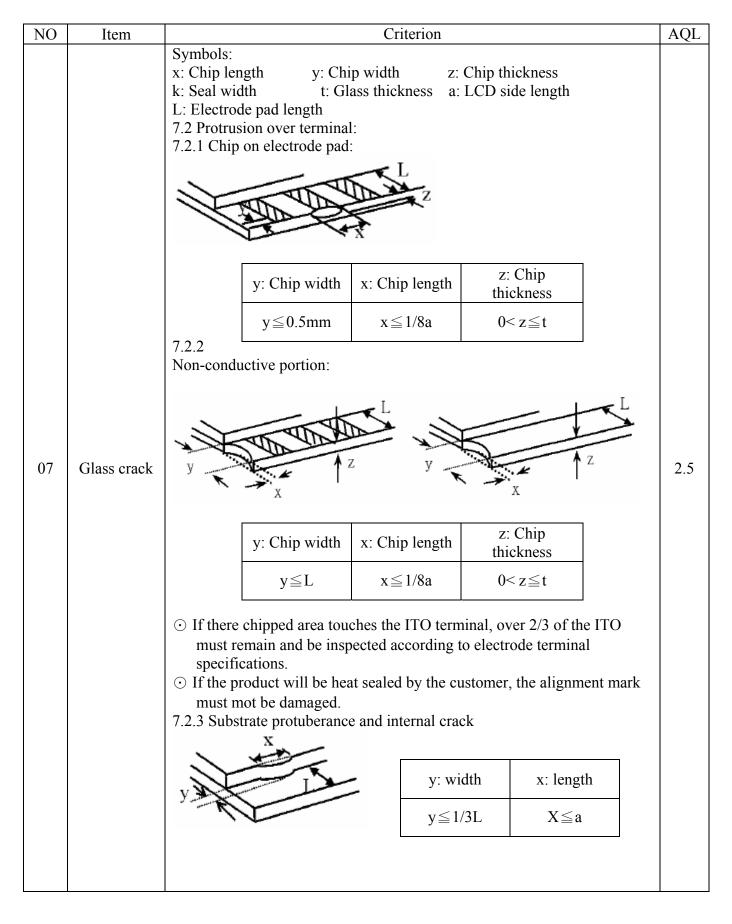
11-6. Inspection specification Defect out of viewing area can be neglected.

NO	Item	Criterion				
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Flicker</li> </ul>				
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 Dot dimension as b $\Phi = (X+Y)/2$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$ $\downarrow$		Size(mm) $\Phi \le 0.20$ .20< $\Phi \le 0.50$ 0.50< $\Phi$	Acceptable Q'ty Accept no dense 5 0	2.5
03	LCD and Touch Panel black spots, white spots,	3.1 Round type: As foll $\Phi = (X+Y) / 2$ $\downarrow \qquad \qquad$	ely spaced:	Size(mm) $\Phi \leq 0.20$ $.20 < \Phi \leq 0.50$ $0.50 < \Phi$ No more than twing)	Acceptable Q'ty Accept no dense 5 0	2.5
	contamination (non – display)	* Densely spaced:	Length( mm) L≦10 L≦10.0 L>10 	Width(mm) W≦0.1 0.1 <w≦0.25  0.25<w< td=""><td>Acceptable Q'ty Accept no dense 4 Rejection Rejection</td><td>2.5</td></w<></w≦0.25 	Acceptable Q'ty Accept no dense 4 Rejection Rejection	2.5
		No more than two			lines within 3mm.	



NO	Item	Criterion				
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size $\Phi(mm)$ $\Phi \leq 0.20$ $0.20 < \Phi \leq 0.3$ $0.50 < \Phi \leq 1.0$ $1.00 < \Phi$ Total Q'ty	Accept no dens           50         4           00         3           0         0		
05	Scratches	Follow NO.3 -2 Line Typ	e.			
06	Chipped glass	k: Seal width t: C L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface $\boxed{z: Chip thickness}  y: C$ $Z \leq 1/2t$ N $\boxed{1/2t < z \leq 2t}$ N $\bigcirc$ Unit: mm $\bigcirc$ If there are 2 or more c 6.1.2 Corner crack: $\boxed{z: Chip thickness}  y: C$ $\boxed{Z \leq 1/2t}$ N	Glass thickness       a: LCE         ce and crack between participation $x$ : C $x$ <	$\frac{1}{18a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$ $\frac{1}{8a}$	2.5	







NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	
09	Backlight elements	<ul> <li>9.1 Illumination source flickers when lit.</li> <li>9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>9.3 Backlight doesn't light or color is wrong.</li> </ul>	
10	Bezel	Bezel must comply with product specifications.	
11	РСВ、СОВ	<ul> <li>11.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>11.2 COB seal surface may not have pinholes through to the IC.</li> <li>11.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places.</li> <li>11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts.</li> <li>11.6 The jumper on the PCB should conform to the product characteristic chart.</li> </ul>	
12	FPC	12.1 FPC terminal damage $\leq 1/2$ FPC terminal width and can not affect the function, we judge accept. 12.2 FPC alignment hole damage $\leq 1/2$ alignment area and can not affect the function, we judge accept.	
13	Soldering	<ul><li>13.1 No cold solder joints, missing solder connections, oxidation or icicle.</li><li>13.2 No short circuits in components on PCB or FPC.</li></ul>	2.5 0.65



NO	Item	Criterion			
14	Touch Panel Chipped glass	<ul> <li>k: Seal width length</li> <li>L: Electrode pad lengt</li> <li>14.1 General glass chi</li> <li>14.1.1 Chip on panel s</li> </ul> I I I I Chip on panel s I I I I I Chip on panel s I I I I I Chip on panel s I I I I I Chip on panel s I I I I I Chip on panel s I I I I I I Chip on panel s I I I I I I I Chip on panel s I I I I I I I I I I I I I I I I I I I	y: Chip width z: t: Touch Panel Total t h	een panels: x: Chip length $x \le 1/8a$	AQL iide
		$z \leq t$ $\odot$ Unit: mm	y: Chip width ≤1/2 k and not over viewing area	x: Chip length $x \le 1/8a$ length of each chip	



NO	Item	Criterion		
15	Touch Panel Fish eye	SIZE(mm)Acceptable Q'ty $L \leq 1.0$ Accept no denseL>1.0mm0	2.5	
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion( $\leq 2.5\%$ ), it is acceptable.		
17	Touch Panel Linearity	Less than 2.5% is acceptable.		
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 10~100g		
19	General appearance	<ul> <li>19.1 Pin type must match type in specification sheet.</li> <li>19.2 LCD pin loose or missing pins.</li> <li>19.3 Product packaging must the same as specified on packaging specification sheet.</li> <li>19.4 Product dimension and structure must conform to product specification sheet.</li> </ul>		



#### **12. Handling Precaution:**

12-1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the FPC and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

#### 12-2 Storage

- Store in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

#### 12-3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: No higher than  $280\pm10^{\circ}$ C and less than 3 sec during Hand soldering.
- Rewiring: no more than 2 times.

#### 13. Guarantee:

Our products meet requirements of the environment.

YEEBO ROHS requirement is based on European Union Directive 2011/65/EU (ROHS) Requirements and Update.